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Dimensions	
Chip Size	1808
L	4.57mm +/-0.38mm (0.18 in +/-0.015 in)
W	2.03mm +/-0.38mm (0.08 in +/-0.015 in)
T	1.6mm MAX (0.063 in MAX)
B	0.51mm +/-0.25mm (0.02 in +/-0.01 in)

Packaging Specifications	
Packaging	T&R, Plastic Tape

General Information	
Series	GR900 SMD Space
Style	SMD Chip
RoHS	Yes
Termination	Tin
Failure Rate	N/A
Testing and Reliability	GR900 CSAM A
AEC-Q200	No
Shelf Life	78 Weeks
MSL	1

Specifications	
Capacitance	3900 pF
Capacitance Tolerance	10%
Voltage DC	200 VDC
Temperature Range	-55/+125°C
Temperature Coefficient	BX

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